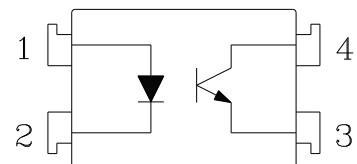


### ● Description

The K1010 T series consist of an infrared emitting diodes, optically coupled to a phototransistor detector. They are packaged in a 4-pin DIP package and available in wide-lead spacing and SMD option.

### ● Schematic



1. Anode
2. Cathode
3. Emitter
4. Collector

### ● Features

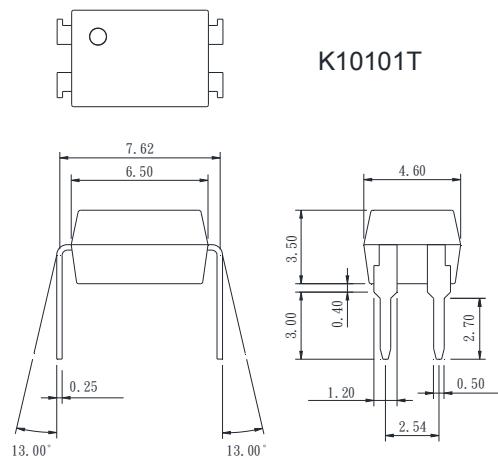
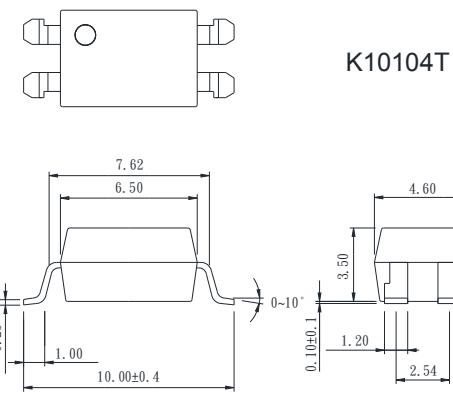
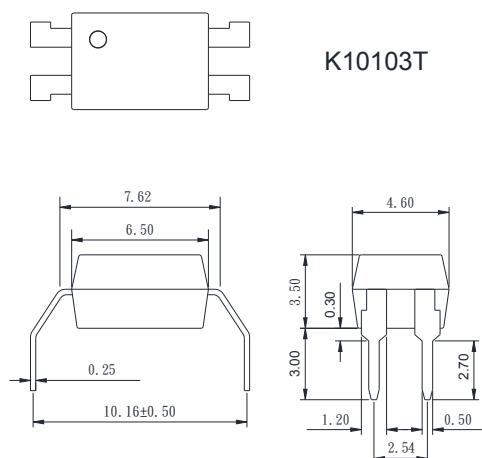
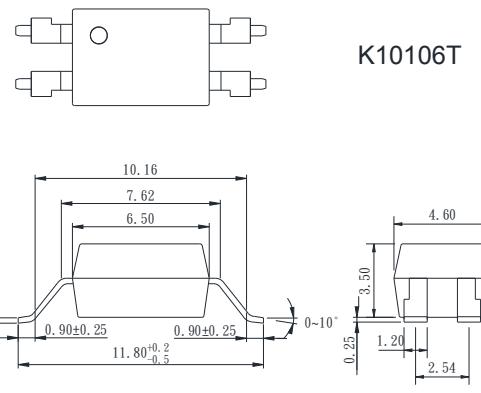
1. Current transfer ratio  
( CTR : Min. 50% at  $I_F=1\text{mA}$   $V_{CE}=5\text{V}$  )
2. High isolation voltage between input and output  
(  $V_{ISO} : 5000\text{VRms}$  )
3. Pb free and RoHS compliant
4. Agency Approvals:
  - UL1577 / CUL C22.2 No.1 & NTC No.5, File No. E169586
  - VDE EN60747, File No.101347
  - FIMKO EN60065, File No. NCS/FI23149 A2
  - FIMKO EN60950, File No. NCS/FI24584 A1
  - SEMKO EN60065, File No. FI016484
  - SEMKO EN60950, File No. FI016433
  - CQC GB4943/GB8898-2011, File No.CQC10001049555 / CQC08001023986

### ● Applications

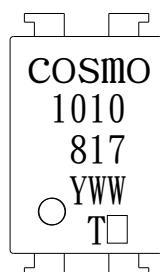
- System appliances
- Measuring instruments
- Computer terminals
- Programmable controllers
- Medical instruments
- Physical and chemical equipment
- Signal transmission between circuits of different potentials and impedances

**● Outside Dimension**

Unit : mm

**1.Dual-in-line type.**

**2.Surface mount type.**

**3.Long creepage distance type**

**4.Long creepage distance  
for surface mount type.**


TOLERANCE : ±0.2mm

**● Device Marking**
**Notes:**

**cosmo**

1010

817

YWW

T

Y : Year code / WW : Week code

□ : CTR rank

**● Absolute Maximum Ratings**

(Ta=25°C)

Parameter		Symbol	Rating	Unit
Input	Forward current	I <sub>F</sub>	50	mA
	Peak forward current	I <sub>FM</sub>	1	A
	Reverse voltage	V <sub>R</sub>	6	V
	Power dissipation	P <sub>D</sub>	70	mW
Output	Collector-emitter voltage	V <sub>CEO</sub>	80	V
	Emitter-collector voltage	V <sub>ECO</sub>	6	V
	Collector current	I <sub>C</sub>	50	mA
	Collector power dissipation	P <sub>C</sub>	150	mW
Total power dissipation		P <sub>tot</sub>	200	mW
Isolation voltage 1 minute		V <sub>iso</sub>	5000	Vrms
Operating temperature		T <sub>opr</sub>	-55 to +115	°C
Storage temperature		T <sub>stg</sub>	-55 to +125	°C
Soldering temperature 10 seconds		T <sub>sol</sub>	260	°C

**● Electro-optical Characteristics**

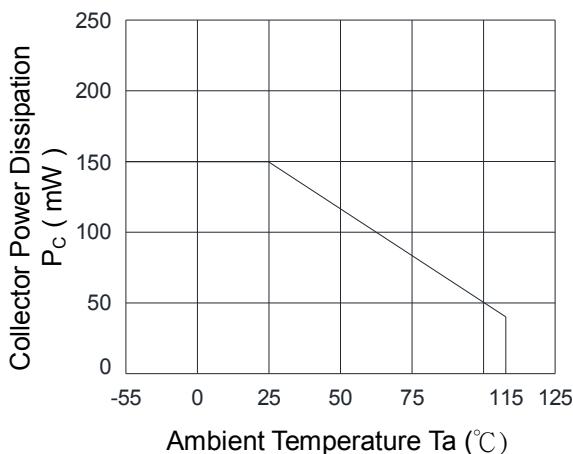
(Ta=25°C)

Parameter		Symbol	Conditions	Min.	Typ.	Max.	Unit
Input	Forward voltage	V <sub>F</sub>	I <sub>F</sub> =20mA	-	1.2	1.4	V
	Peak forward voltage	V <sub>FM</sub>	I <sub>FM</sub> =0.5A	-	-	3.0	V
	Reverse current	I <sub>R</sub>	V <sub>R</sub> =4V	-	-	10	μA
	Terminal capacitance	C <sub>t</sub>	V=0, f=1KHz	-	30	-	pF
Output	Collector dark current	I <sub>CEO</sub>	V <sub>CE</sub> =20V, I <sub>F</sub> =0	-	-	0.1	μA
Transfer characteristics	Current transfer ratio	CTR	I <sub>F</sub> =1mA, V <sub>CE</sub> =5V	50	-	600	%
	Collector-emitter saturation	V <sub>CE(sat)</sub>	I <sub>F</sub> =20mA, I <sub>C</sub> =1mA	-	0.1	0.2	V
	Isolation resistance	R <sub>iso</sub>	DC500V	5x10 <sup>10</sup>	10 <sup>11</sup>	-	Ω
	Floating capacitance	C <sub>f</sub>	V=0, f=1MHz	-	0.6	1.0	pF
	Cut-off frequency	f <sub>C</sub>	V <sub>CC</sub> =5V, I <sub>C</sub> =2mA, R <sub>L</sub> =100Ω	-	80	-	KHz
	Response time ( Rise )	t <sub>r</sub>	V <sub>CE</sub> =2V, I <sub>C</sub> =2mA, R <sub>L</sub> =100Ω	-	4	18	μs
	Response time ( Fall )	t <sub>f</sub>		-	3	18	μs

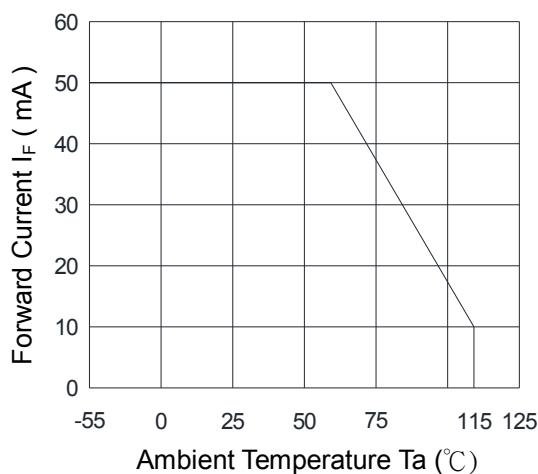
**Classification table of current transfer ratio is shown below.**

K1010 T Model No.	CTR (%)
K1010 TA	100 ~ 600
K1010 TE	50 ~ 600

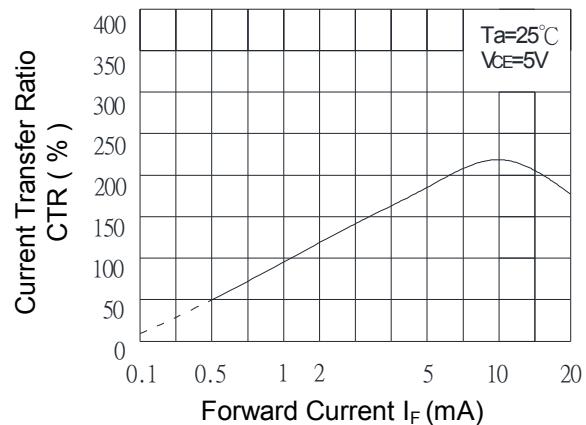
**Fig.2 Collector Power Dissipation vs. Ambient Temperature**



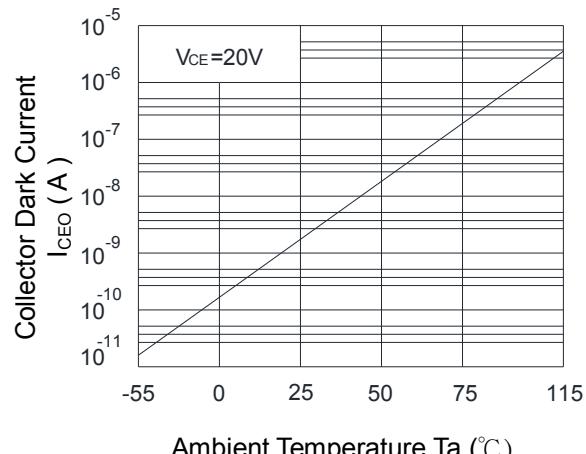
**Fig.4 Forward Current vs. Ambient Temperature**



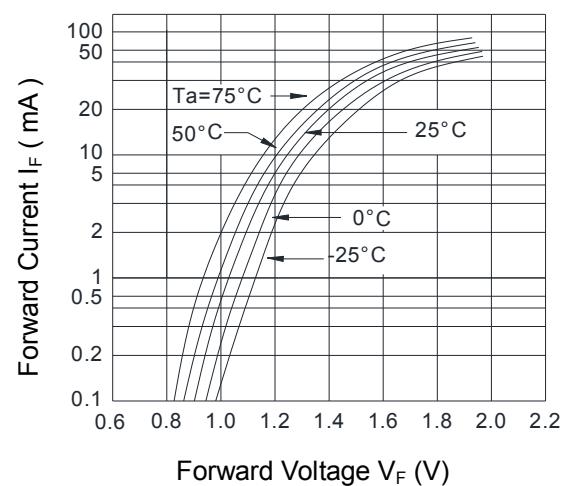
**Fig.1 Current Transfer Ratio vs. Forward Current**



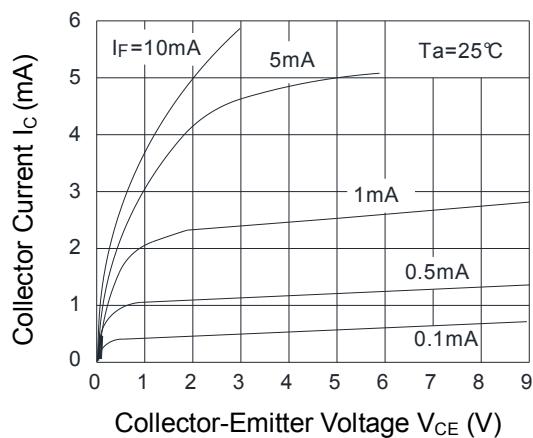
**Fig.3 Collector Dark Current vs. Ambient Temperature**



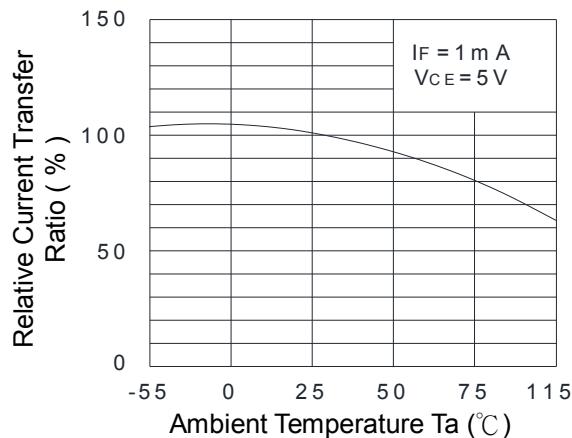
**Fig.5 Forward Current vs. Forward Voltage**



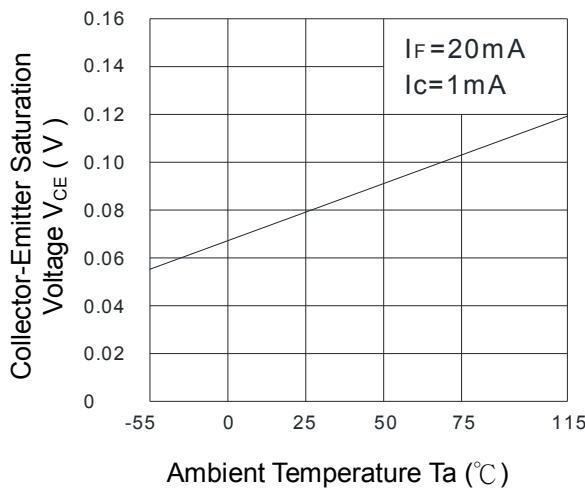
**Fig.6 Collector Current  
vs. Collector-Emitter Voltage**



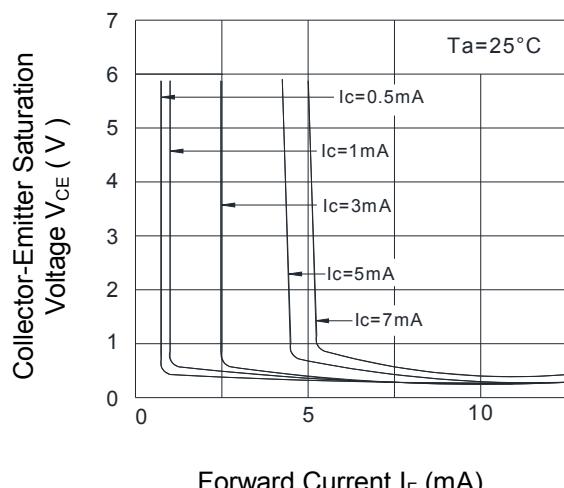
**Fig.7 Relative Current Transfer Ratio  
vs. Ambient Temperature**



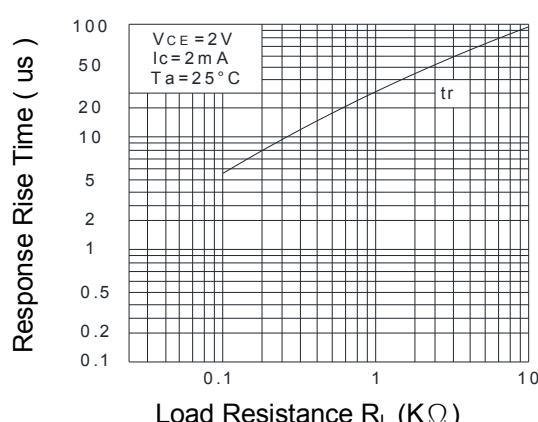
**Fig.8 Collector-Emitter Saturation Voltage  
vs. Ambient Temperature**



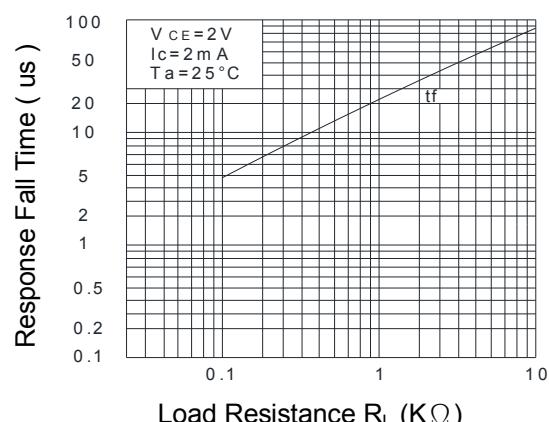
**Fig.9 Collector-Emitter Saturation  
Voltage vs. Forward Current**



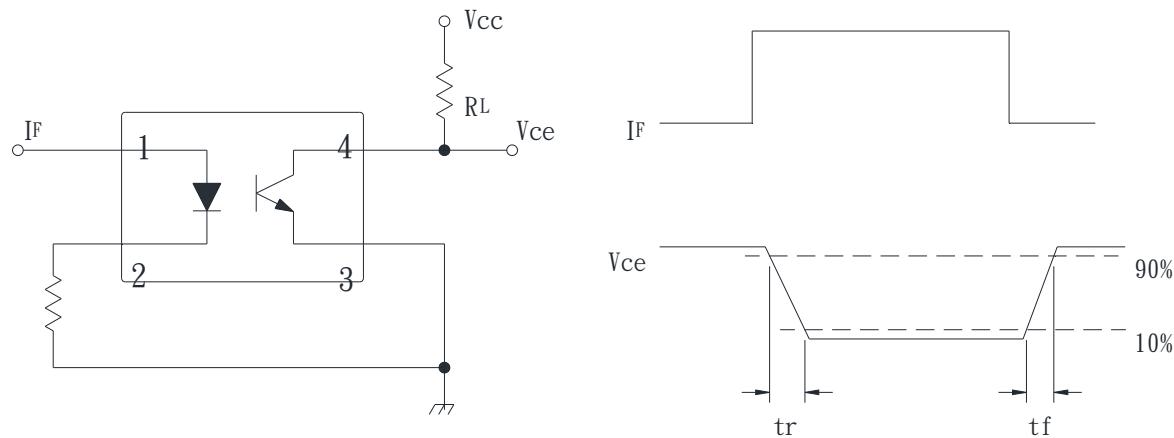
**Fig.10 Response Time (Rise)  
vs. Load Resistance**



**Fig.11 Response Time (Fall)  
vs. Load Resistance**



- Test Circuit for Response Time

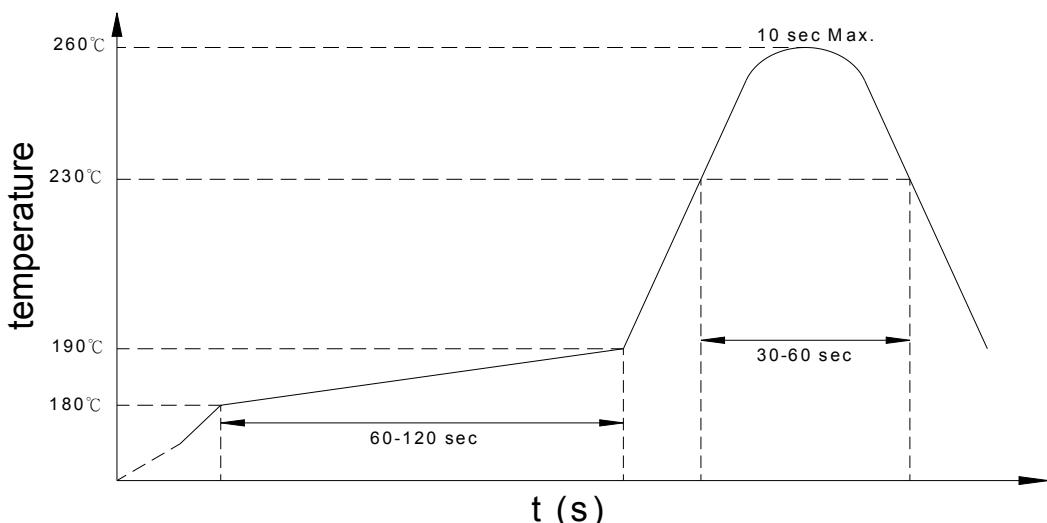


- Recommended Soldering Conditions

- (a) Infrared reflow soldering :

- Peak reflow soldering : 260°C or below (package surface temperature)
- Time of peak reflow temperature : 10 sec
- Time of temperature higher than 230°C : 30-60 sec
- Time to preheat temperature from 180~190°C : 60-120 sec
- Time(s) of reflow : Two
- Flux : Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

**Recommended Temperature Profile of Infrared Reflow**



- (b) Wave soldering :

- Temperature : 260°C or below (molten solder temperature)
- Time : 10 seconds or less
- Preheating conditions : 120°C or below (package surface temperature)
- Time(s) of reflow : One
- Flux : Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

- (c) Cautions :

- Fluxes : Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.
- Avoid shorting between portion of frame and leads.

- Numbering System

**K1010 X T Y (Z)**

**Notes:**

K1010 = Part No.

X = Lead form option (1,3,4,6)

Y = CTR rank option (A, E)

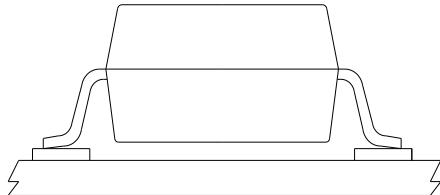
Z = Tape and reel option (TLD,TRU)

Option	Description	Packing quantity
4 (TLD)	surface mount type package + TLD tape & reel option	2000 units per reel
4 (TRU)	surface mount type package + TRU tape & reel option	2000 units per reel
6 (TLD)	long creepage distance for surface mount type package + TLD tape & reel option	2000 units per reel
6 (TRU)	long creepage distance for surface mount type package + TRU tape & reel option	2000 units per reel

- Recommended Pad Layout for Surface Mount Lead Form

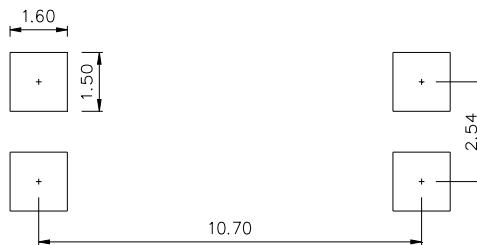
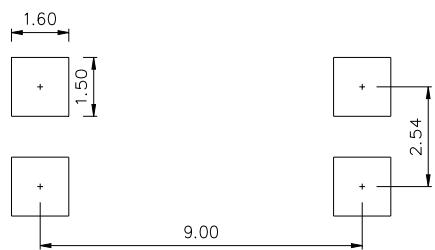
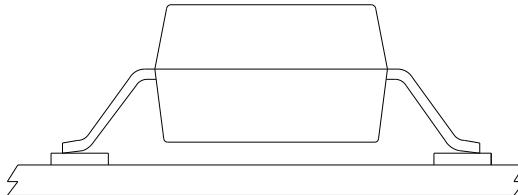
1. Surface mount type.

4 pin SMD



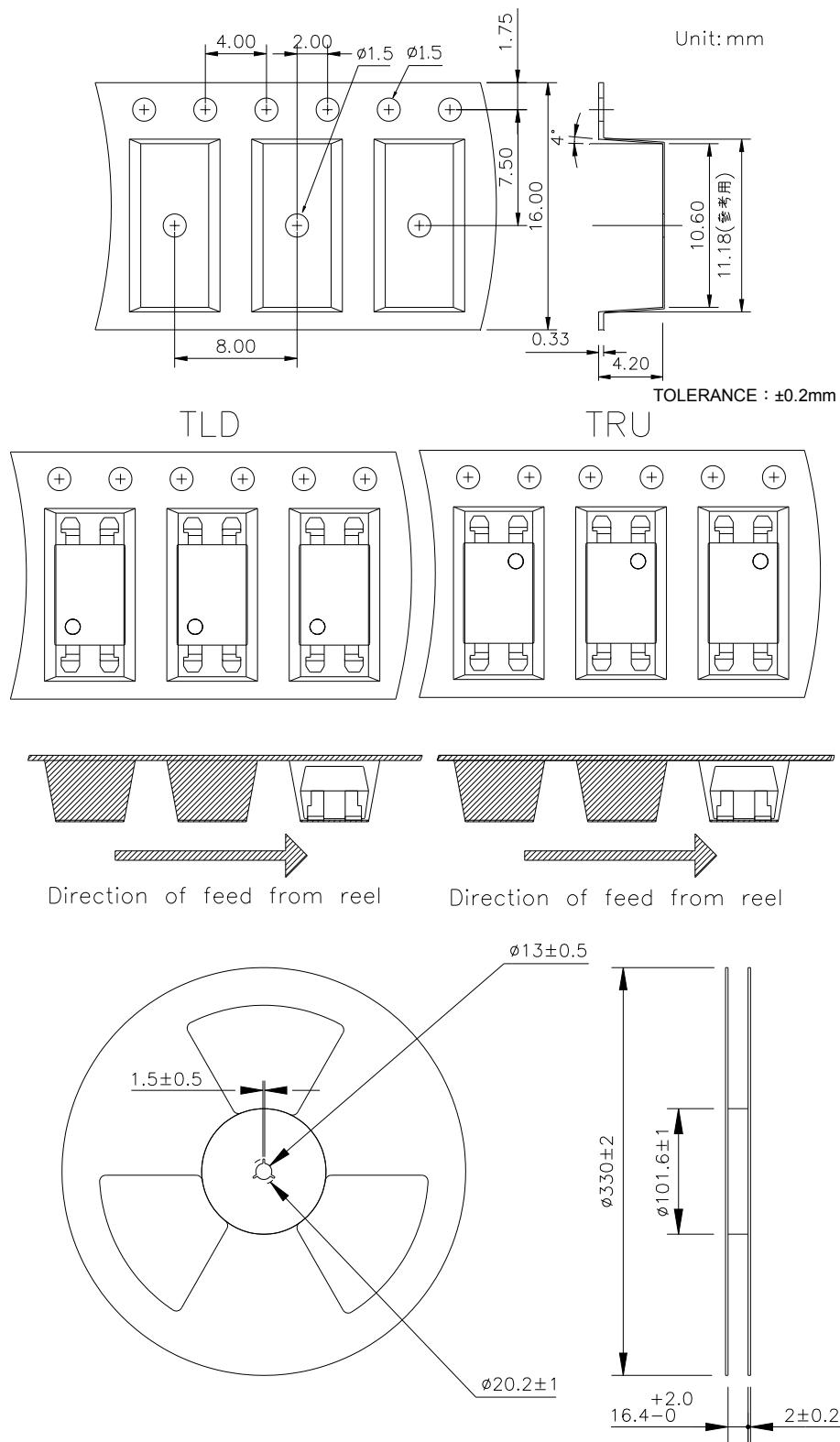
2. Long creepage distance  
for surface mount type.

4 pin L

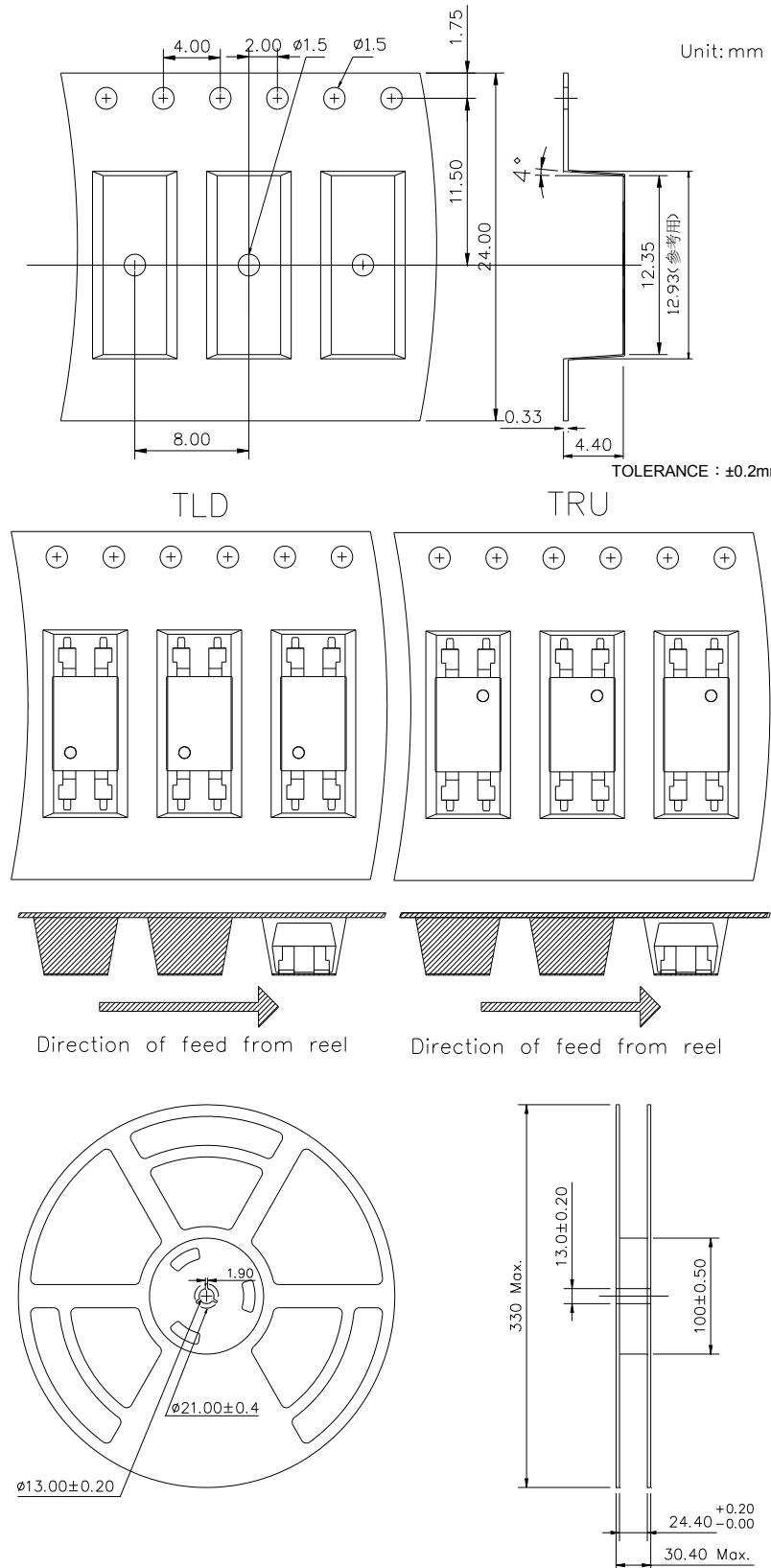


Unit : mm

- 4-pin SMD Carrier Tape & Reel



- 4-pin L Carrier Tape & Reel



## ● Application Notice

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- c. Audio / Video
- d. Instrumentation
- e. Electrical application
- f. Measurement equipment
- g. Consumer electronics
- h. Telecommunication

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- b. Space application
- c. Telecommunication equipment (trunk lines)
- d. Nuclear power control
- e. Equipment used for automotive vehicles, trains, ships...etc.

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